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MASTER THESIS IN

ADVANCED ELECTROMAGNETIC TRANSMISSION TECHNIQUES AND DEVICES

Time-Modulated Array Co-Simulation with the Aid of Commercial Software

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Abstract

This thesis report exhibits an integrated Electromagnetic/Circuit level technique to analyze the time modulated arrays. I restate this work in commercial software which was already developed in CAD domain i.e. combining the exact harmonic balanced based analysis of non-linear switches with the electromagnetic characterization of the radiating elements. In this commercial software I try to perform a full-wave co-simulation to compute the radiated far-field envelope to show the array behavior. Simulation in this new software allows a precise evaluation of several non-linear performance aspects of the radiating system, such as power usage capabilities and the switch modulation frequency boundary.

Secondly I also discuss a TMA wireless power transfer technique which is based on two step procedure. In this case I carry out the full wave co-simulation in this new commercial software to analyze the antenna array with modulated non-linear feeding network. Schottky-diode based network provide proper modulated RF excitations of the array elements. Therefore, the array architecture is extremely simple, if compared to phased arrays, only simple control circuit board.

1. Time Modulated Array

1.1 Introduction

The wireless domain that requires mounting mobility, capacity and robustness have enhanced wireless communications as the most efficient, progressive sector of the telecommunication industry nowadays. As a result, the increasingly limited wireless medium has to be efficiently utilized. In doing so, antennas are used. Antennas play a significant role in achieving the development. A proper modification and enhancement of features of the antenna and sound signal processing allow us to act in the space, frequency efficiently, and time domains to bestow a viable option to the complex task of realistically addressing the required signals. It also helps to mitigate the unwanted ones.

The research centered on the development of new technologies allows for reduced power consumption of sensor networks. It aims at the elaboration of smart antennas with low loss of power, muting, and adaptive beamforming features. Besides this, a smart antenna technology has to take into account the hardware complexity, making the solution feasible in the context of sensors. Moreover, antenna devices development to suit the needs of sensor networks must be efficient enough to sense the external electromagnetic environment, thus appropriately reconfiguring the radiation characteristics of the generated field. It will assure both the necessary quality of service of the communication link and reduced power consumption.

This chapter demonstrates the use of time modulation as new statistics in the design of ultralow side-lobe level arrays. This solution offers less tolerance errors with respect to conventional tapered amplitude excitations, but suffers from the existence of unwanted radiation in correspondence of sideband signals spaced at multiples of the modulation frequency. Various solutions exhibit the feasibility of time-modulated arrays featuring both side-lobe reduction and sideband suppression by exploiting the design parameters offered by the switch modulation laws. Anyway, more recently, sideband radiation of TMAs has demonstrated to be a deployable additional feature of these radiating systems, as will be better described in next section. An important improvement in time-modulated arrays (TMA) performance comes out from the removal of the common start time condition for the switches and the introduction of different switching strategies in which the element "switch-on" times can be arbitrary [2]. In one of these approaches the switch modulation period is divided into elementary time intervals of the same duration and a binary genetic algorithm is used to select the ENABLE-DISABLE states of the switches.

Some extent infinite control sequence combinations together with the ease of putting into use make the TMA a multifaceted and adequate radiation system for contemporary wireless

applications. The real-time reconfigurability of the radiation pattern designates the TMA as the best possible prospect for software-defined radio solutions.

Although, the conveniently accessible design approaches fundamentally make use of isotropic radiators and invariably presume ideal switches in the optimization process, it causes a noteworthy loss of information regarding the physical reality. Mainly, the aspects that cannot be considered encompass of the actual antenna radiation pattern and possible electromagnetic interactions along with the feeding network. It also includes the nonlinear behavior of the switching devices and lastly the intrinsic dynamics of the radiation mechanism.

The goal of this thesis work is to provide a rigorous design approach to TMAs by means of available commercial softwares.

However, various technical problems continue to exist to develop the necessary antenna technologies which have the potential to support the features mentioned above in a contained physical space that the mobility demand domineers. As a matter of fact, modern wireless merits contemplate the multiple-antenna techniques to utilize space variation, spatial multiplexing, and beamforming to attain excellent standards. It is done to enhance reliability and increase the capacity. Such a useful framework is achieved at the cost of several system complexities. They may be unaffordable in small-size and low-cost sensor appliances and devices with the necessary low power utilization.

The idea of TMA is a feasible multi-antenna method that provides an important hardware to make less complex [2]. Furthermore, TMA, represent as unconventional phased arrays architectures, have been intensively researched during the previous years at a rising rate.

1.2. TMA Wireless Power Transfer

In this chapter, a smart wireless power transmission technique is discussed which is based on a 2-step procedure to exploit real-time beaming of TMA. In this case the drawback of sideband radiation of these radiating systems favorably used for on purpose wireless power transfer (WPT).

In the first step to accurately localize the tag to be powered and in the second one to perform directive WPT [1]. The approach is first theoretically discussed, and then the numerical procedure, which integrates full-wave analysis of the antenna array with nonlinear simulation of the modulated nonlinear feeding network, is used to validate the principle of operation and to include nonlinearities and electromagnetic couplings affecting the whole system performance.

The procedure allows a flexible design of the time-modulated- array-based WPT system, taking into account the impact of array elements layout and spacing on localization and power transmission performance.

Simulation of the first step is carried at 2.45 GHz, with a Schottky-diode-based network to provide proper modulated RF excitations of the array elements.

TMA radiation at Fundamental and Sideband frequencies

Non-linear switches are driven by periodical control sequence at TMA elements ports which leads to nearly infinite number of excitation combinations, not only the switch on percentage but also the rise and fall instants. In this case optimization procedure can be adapted to manipulate an extreme versatility of these radiating systems. Figure 1.1 shows very simple architecture for a standard linear array [1].



Figure.1.1 Schematic illustration of a linear n_A -element TMA with comprehensive diodes switch bias networks, with dc-block capacitors.

This is an extremely simple array architecture, like if compared to the phase arrays. There isn't required complex phase shifter but control boards only which is simple. Furthermore, TMA additionally offers known capability which is not feasible for other radiating architecture represented by a multi-frequency radiation mechanism and the focus of this chapter will represent this.

Let's start to consider a linear array whose n_A elements are resonant at fundamental frequency f_0 and along the direction $\hat{a}(\hat{a}.\hat{r} = \cos\phi)$ are aligned with L spacing inter-element [1]. At the ith antenna port is the RF switch driven by a sequence which is periodical rectangular pulses of period $T=\frac{1}{f_M}$ and $U_i(t)$ normalized amplitude which leads to replaced the constant excitation coefficient A_i with time-dependent version $A_i U_i(t)$. In this way the whole array radiated far-field becomes time dependent as well. This time dependency of the array factor AF as breakdown in the following field evaluation in the point $((r, \theta, \phi))$:

$$\boldsymbol{E}(r,\theta,\phi,t) = \boldsymbol{E}_{\mathbf{0}}(r,\theta,\phi) \sum_{i=0}^{n_{A}-1} A_{i} U_{i}(t) e^{ji\beta L\cos\psi} = \boldsymbol{E}_{\mathbf{0}}(r,\theta,\phi) \operatorname{AF}(\theta,\phi,t)$$
1.1

Where the free-space phase constant is β , and E_0 represents the radiated far-field at the carrier frequency f_0 radiated by the base element of the array. Because of periodicity the control switch sequence is possible to Fourier transform the time dependent array factor.

$$\operatorname{AF}(\theta, \phi, t) = \sum_{h=-\infty}^{\infty} \operatorname{AF}_{h}(\theta, \phi, t) = \sum_{h=-\infty}^{\infty} e^{j2\pi(f_{0}+hf_{M})t} \sum_{i=0}^{n_{A}-1} A_{i}u_{hi}e^{ji\beta L\cos\psi}$$
1.2

Where U_{hi} is the hth Fourier coefficient of the $U_i(t)$ pulse.

Definitely, at the fundamental frequency $f_0(h=0)$ the TMA is able to radiate but this happens also at sideband harmonics $f_0 \pm hf_M(h=\pm 1, \pm 2..)$. This sideband radiation (SBR) is efficiently received/transmitted due to the modulation frequency f_M which is low value with respect to the carrier f_0 (MHz v/s GHz). In this case the array elements still almost resonant. In the start of TMA's usage, the phenomenon of sideband radiation (SBR) has represented an unwanted radiation. In this chapter there are multiple efforts taken into account to suppress this power wastage. In fact, we intend to exploit the capabilities of direction finding and harmonic beaming to realize a new and smart WPT procedure strategy.

In second chapter there is a detailed explanation of the procedure and also the simulation results taken from commercial software.

Chapter 2. Simulation of Time Modulated Array with Commercial Software

This chapter primarily examines **active microwave circuit design**, an important part of microwave engineering. This subject has worldwide appeal given the incredible growth in mobile and satellite communications. In the past, the use of microwaves was limited to radars and weapon systems, and to remote sensing and relay systems. However, due to the rapid expansion of mobile and satellite communication systems in recent years, systems that use radio waves or microwaves can be found in almost every sphere of our lives. The design environment for active microwave circuits has changed drastically with the continuous expansion of microwave applications into our daily lives. Recently, a variety of software design tools applicable to circuit design, system design, and electromagnetic analysis of passive structures has emerged. This has significantly reduced the need for analytical methods and specific design-oriented, in-house programs for the design of circuits and systems. With these advances, the rapid exchange of results between designers has facilitated independent study and experimentation with basic concepts using software tools and practical designs. Clearly, innovations in the field underscore the necessity for advanced education in active microwave circuit design and improvements to relevant software tools.

The popular Advanced Design System (ADS) from Agilent Technologies is the design tool used in the chapter as it has the longest proven track record compared to other design software. However, since most features of ADS are also available in other, similar design software, I believe that selecting ADS as the design tool will not present any critical limitations.

Previously we were using old design software at University of Bologna for the simulation which has high performance, even compared to commercial ones, but lacks in nonlinear device libraries, The purpose of my thesis job is to introduce the new software in university that has vast features and built-in powerful tools and plenty of library devices which we can perform full scale-simulation efficiently, especially a nonlinear/electromagnetic co-simulation for TMA analysis.

2.1. Advanced Design System

"Advance Design System" is the world's leading electronic design automation software for RF, microwave, and high speed digital applications. In a powerful and easy-to-use interface, ADS pioneers the most innovative and commercially successful technologies, such as X-parameters*

and 3D EM simulators, used by leading companies in the wireless communication & networking and aerospace & defense industries [3]. For WiMAX[™], LTE, multi-gigabit per second data links, radar, & satellite applications, ADS provides full, standards-based design and verification with Wireless Libraries and circuit-system-EM co-simulation in an integrated platform.

While the Key Benefits of ADS are:

- Complete, integrated set of fast, accurate and easy-to-use system, circuit & EM simulators enable first-pass design success in a complete desktop flow.
- Application-specific Design Guides encapsulate years of expertise in an easy-to-use interface.
- ADS is supported exclusively or months earlier than others by leading industry and foundry partners.

Advanced Design System (ADS) continues to lead the RF EDA industry with the most innovative and commercially successful technologies, including Harmonic Balance, Circuit Envelope, Transient Convolution, Keysight Ptolemy, X-parameter*, Momentum and 3D EM simulators (including both FEM and FDTD solvers). With ADS's Wireless Libraries and circuit-system-EM cosimulation technology, ADS provides full, standards-based design and verification within a single, integrated platform.

Key Features & Specifications:

ADS Core is the starting element to build up your design and simulation capabilities. It already contains powerful features [3].

- Project design environment to input schematics, launch simulations and manage design projects
- Data display to manipulate and plot data
- Linear simulator for S-parameters, DC and small signal AC analysis
- RF system simulator
- Additional model libraries- RF system, RF passive and multilayer interconnects
- Passive circuit design guide to synthesize matching networks and passive functions

Advanced Design System Users

There are different users who can use as per their requirement which are mentioned below [3]:

- MMIC Designers
- Signal Integrity Engineers
- **RFIC** Designers
- RF & Microwave Board Designers
- RF System-in-Package & RF Module Designers
- Power Electronics Designers

In this chapter we worked as a **RF & Microwave Board Designers.** Ever increasing substrate layer counts, smaller form factors, complex packaging technologies, and closer design proximity continue to make RF/MW board designs ever more challenging. ADS provides integrated system, circuit, and EM simulators, layout, and powerful optimizers to help increase productivity and efficiency, validating high-yield designs prior to manufacturing. ADS works with framework integration products, such as Mentor and Cadence, to fit in your design flow. For general information on Keysight's solutions, refer to RF & Microwave Board Design.

Key Success Factors for RF Board Design Flows

The keys to success in creating an efficient, practical RF Board design flow include:

- The Widest variety of synthesis capabilities that enable RF Board designers to explore alternatives quickly and balance RF performance, parts count, and board area, within seconds, as well as to assess the cost-effectiveness of whether to make or buy a commercial component.
- Accurate model libraries that support different simulation domains for various applications. Behavioral models are also important for initial system level designs and they can be extracted from datasheet, measurement, or simulation based.
- Comprehensive vendor supplied libraries that enable the simulation of off-the-shelf components.
- Accurate RF/microwave physical models such as microstrip, stripline, and coplanar waveguide.
- Comprehensive simulation technologies in one environment including linear/nonlinear in frequency and time domain

ADS Design Environment

This section describes the ADS Design Environment.

ADS Main Window

The ADS Main window (also referred to as Main window) is your first interface to start using the ADS. It helps you to access all the features supported by ADS [3]. It allows you to:

- Create and manage a workspace. For more information, refer to Workspace.
- Organize design data in virtual folders.
- Open design view(s) and data display window.
- Perform design flow settings. For more information, refer to Design Flow Settings.
- Set program preferences. For more information, refer to Setting Preferences for Miscellaneous Options.
- Change toolbar configuration and keyboard shortcuts (Tools > Hot Key/Toolbar Configuration)
- Manage technology associated with a workspace. For more information, refer to Technologies.
- Record and play macro. For more information, refer to Playing an AEL Macro.
- Load AEL files/commands from the Command line. For more information, refer to Command Line.
- Launch the text editor. For more information, refer to Using the Text Editor.
- Show/Hide all windows.
- Index large workspaces.
- Convert projects (created using ADS 2009 Update 1 or earlier versions) to a workspace. For more information, refer to Converting Projects to Workspaces.
- Access examples that ship with ADS. For list of examples that are shipped with ADS, refer to Examples.
 ADS allows you to open only one workspace for a given instance.



- Title bar displays the window name.
- Menu bar displays the menus available.
- Toolbar contains buttons for frequently used commands.
- View tabs contains the workspace view options.

Workspace Views

The following table describes the workspace view options [3].

Views	Description
File View	The file view tab helps you to:
	Browse to other directories (similar to previous releases).
	See the actual files that are stored in the file system.
	See special characters in cell names shown in parenthesis to improve readability (special characters are used by OpenAccess for cross-platform support).
	Open the listed workspaces by:
	 Right-clicking on the workspace and selecting Open Workspace.
	 Double-click on the selected workspace.
Folder View	The folder view tab helps you to:
	Create virtual folders to group related files (similar to previous releases).
	 Once a workspace is open, ADS automatically switches to the Folder View tab where it displays all the contents of that workspace.
Library View	The library view tab helps you to:
	View the system organization of a workspace.
	Find files by type.

Design Views

You can create schematic, symbol, and layout design views. A design can consist of a number of schematics and layouts embedded as subnetworks within a single design. Views allow you to modify the schematic, layout and symbol independently.

You can create multiple views to control simulations and track design revisions. Layout and schematic toolbars have been reconfigured to various smaller toolbars. This enables you to personalize ADS to your needs. For information on reconfigured toolbars, see Layout and Schematic Toolbars.

New and improved Layout and schematic hotkeys. There are now single-key hotkeys for various common operations such as M for move. For information on list of hotkeys, see Layout Hotkeys.

Schematic View

In schematic view you can create designs:

- By placing components, pins, data items, units, variables, and equations.
- Using a template. You can also save your design as template. For more information on templates, see Simulation Templates.
- Using the Schematic Wizard that helps you prepare the design for simulation. For more information, see Schematic Wizard.

• You can select either Enable the Schematic Wizard or Schematic Design Templates options simultaneously.

Setup must be configured before starting any design. There are many ways to configure the program defaults. The best configuration depends on the type of designs created, the available options, and the type of final output required.

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- The Title bar displays the window type, design type, filename, and a number identifying the type of window.
- The Menu bar displays the menus available in that window.
- The Toolbar contains buttons for frequently used commands and for choosing the appropriate orientation for components. The collection of buttons on the toolbar is configurable (Tools > Hot Key/Toolbar Configuration) and can be toggled on and off (View > Toolbar).
- The Palette List enables you to choose a category of components to place on the Component Palette.
- The Component History drop-down list is continuously updated to reflect the components you have placed in your design. It provides a quick method of placing another instance of a component in your design and can be used as a starting point for creating a custom palette.
- The Drawing area is where you create your designs.
- The Component Palette contains buttons for placing components.
- The Prompt panel provides messages to assist you during the execution of most commands, as well as various pieces of information to assist you in creating a design.
- The Pop-up menu enables you to access many common commands with a minimum of mouse movement. You access the pop-up menu by pressing the right mouse button in the drawing area of any design window. The context-sensitive commands appear on the pop-up menu when the pointer is positioned over certain shapes or text and on right click.

Symbol View

To create a new Symbol, follow the steps below [3]:

- 1. Start ADS and open an existing workspace or create a new workspace.
- 2. From the main ADS Window, use any of the three options to open the New Symbol dialog box:
 - Select File > New > Symbol.
 - Click New Symbol button (¹)from the toolbar.
 - Right click on the workspace name and select New Symbol option.
 From the Library drop-down list, select the library name where the new Symbol will be stored.

Enter the new cell name or click the Browse Cells button to select cell from the existing cells of the selected library.

Click Edit View Name to create a new symbol view with the default name, i.e., Symbol or a new view name in View Name Editor window.

Click OK to open the symbol window where you create a Symbol View.

The following figure displays the Symbol view.



Layout View

To create a new Layout, follow the steps below [3]:

- 1. Start ADS and open an existing workspace or create a new workspace.
- 2. From the main ADS Window, use either of the three options to open the New Layout dialog box:

- Select File > New > Layout.
- Click New Layout button (
 from the toolbar.
- Right click on the workspace name and select New Layout option.

From the Library drop-down list, select the library name where the new layout will be stored.

Enter the cell name or click the Browse Cells button to select cell from the existing cells of the selected library.

Click Edit View Name to create a new layout view with the default name, i.e., Layout or a new view name in View Name Editor window.

Click OK and the layout window opens where you create the Layout View.

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The following figure displays the Layout view.

Data Display Window

The Data Display window allows you to [3]:

- View and analyze the data generated by simulation, as well as that has been imported from other sources, such as a network analyzer or CITIfile.
- Display data in a variety of plots and formats.
- Create plots with more than two axes.
- Add markers to traces to read specific data points.
- Write mathematical equations to perform complex operations on data, and display the results.
- Add text and drawing objects to enhance your documentation.

• Edit plot titles and axis labels, equations, text, drawing objects, and column headings in lists.



The following figure displays the Data Display window.

Exiting from ADS

To exit the ADS program from the Main window or any of the design windows, perform the following [3]:

1. Select File > Exit from the Main window

or

Select File > Exit Advance Design System from any design window (such as Symbol, Schematic, or Layout).

The Save Modified Designs window is displayed.

2. Click Yes to save and exit.

Using Designs

ADS allows you to create various designs such as, schematic, symbol, and layout [3]. A design can consist of one or more schematics and layouts embedded as subnetworks within a single design. All designs in a workspace can be displayed and opened directly from the ADS Main window. The designs are stored in a cell.

An ADS design window is used to [3]:

- Create and modify circuits and layouts.
- Add variables and equations.
- Place and configure components, shapes, and simulation controllers.
- Specify layer and display preferences.
- Include annotations using text and illustrations.
- Generate layouts from schematics (and schematics from layouts).

Creating a New Schematic

Following are the steps to create a new Schematic:

- 1. Open an existing workspace, or create a new workspace.
- 2. Select **File > New > Schematic** from the ADS Main window, to open the New Schematic dialog box.
- 3. From the Library drop-down list, select the library name where the new schematic is stored.
- 4. Enter the new cell name or click Browse Cellsto select the cell from existing cells of the selected library.

By default, a view is created in a new cell. To add it to an existing cell, change the cell name or as a shortcut, instead of using File > New > Schematic. You can rightclick on an existing cell in the Folder View or Library View and select New Schematic.

🌆 New S	chematic	23
Library:	SimModels_lib	•
Cell:	cell_1	Browse Cells
View:	schematic	Edit View Name
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Schema <none< td=""><th>atic Design Templates (Option >></th><td>nal):</td></none<>	atic Design Templates (Option >>	nal):
(OK Cancel	Help

- 5. Click Edit View Name to create a new view.
- 6. Select the template from Schematic Design Templates list, or check the Enable the Schematic Wizard to start the Schematic Wizard.
- 7. Click OK. The new schematic window is displayed.

Creating a New Layout

To create a new Layout, follow the steps below:

- 1. Start ADS and open an existing workspace, or create a new workspace.
- 2. From the ADS Main window, select **File > New > Layout** to open New Layout dialog.

🚻 New l	.ayout
Library:	SimModels_lib 💌
Cell:	cel_1 Browse Cells
View:	layout Edit View Name
	Connectivity: Net-based Change
	OK Cancel Help

- 1. From the Library drop-down list, select the library name where the new layout is stored.
- 2. Enter the new cell name or click the Browse Cells button to select cell from the existing cells of the selected library.
- 3. Click Edit View Name to create a new view.
- Click Change to change the connectivity mode for the new layout. For detail information, see Connectivity Modes.

The Design Connectivity Options dialog box is displayed.

Creating a New Symbol

To create a new Symbol, follow the steps below:

- 1. Open an existing workspace, or create a new workspace.
- 2. Select File > New > Symbol from the ADS Main window, to open the New Symbol dialog box.

🔟 New S	ymbol	23
Library:	SimModels_lib	•
Cell:	cell_1	Browse Cells
View:	symbol	Edit View Name
[(OK Cancel	Help

- 3. From the Library drop-down list, select the library name where new symbol is stored.
- 4. Enter the new cell name or click Browse Cells to select cell from the existing cells of the selected library.
- 5. Click Edit View Name to create a new view.
- 6. Click OK.

The new symbol window is displayed.

Momentum

To calculate passive structures and antenna, methods based on electromagnetic theory have been developed in the past and are still being studied but the method of calculation varies considerably depending on the structures.

The structure analysis that uses Maxwell equations for electromagnetics is known as EM simulation (electromagnetic simulation). The EM-simulation tool for a planar structure is built into ADS and is called Momentum.

Settings and EM Simulation

Substrate and Layout Layers

Momentum provides electromagnetic solutions for a planar structure (a vertically uniform dielectric structure), the substrate structure (the vertical structure) composed of multiple substrate layers must first be specified. Also, users should map multiple metallization layers on the substrate layers. For the specified substrate and metallization structures, Momentum calculates the Green's functioned and stores it for calculation efficiency.

Figure 2.1 shows a window for determining the substrate structure[4]. On the menu bar of the ADS Layout window, select Momentum > Substrate > Create/Modify to display the window shown in Figure 2.2. The Substrate Layers tab in the figure defines the structure of the substrate. The dielectric structure in this example consists of FreeSpace, Alumina, and GND. When multilayers are required, a new substrate layer can be added by clicking Add; layers can also be deleted by clicking Cut. The boundary conditions for FreeSpace are the same as the properties in free space. FreeSpace can be set to a shielded structure, where a conductor plate is placed at the ceiling. By clicking the layers in the dielectric structure, its parameters can be modified. For example, click the dielectric layer Alumina and activate the window that defines the attributes of that dielectric layer. The Dielectric Thickness and Substrate Layer Name can be specified. The specifications for each layer are completed by entering the Thickness, Dielectric Permittivity, and Dielectric Loss Tangent information for each dielectric. Its permittivity Er and permeability Mu can be defined in a variety of formats. The permittivity and permeability are defined in terms of the general Re, Loss Tangent form and it is also possible to define them in other ways.

tame: example.Jay		
Select a substrate layer to adit OR daf	ine a new layer:	
lubstrate Layers FreeSpace Alumina	Thickness 10 mil 👻	Substrate Layer Name Alumina
////// GNU ///////	- Permittivity (Er)	- Permeability (MUr)
	Re, Loss Tangent 🗸 🗸	Re, Loss Tangent 🔗
	Real	Real
	9,6	1
	Loss Tangent	Loss Tangent
	0	0

Figure 2.1 Substrate Layer tab window

Next, the location of the metallization must be specified for the calculation of the Green's function, which is done by opening the *Layout Layers* tab and specifying the metallization on which the substrate layer is located. The window for the *Layout Layers* tab is shown in figure 3.

Select a layout layer to map to the substrate Layer Mapping Substrate Layers FreeSpace 	Layout Layer	cond	2007.007	>	
Alemina /////// GND ///////	Thickness	D	mil	> >	
	Material	Perfect Condu	uctor	~	

Figure 2.2 Layout Layers tab window

This process is absolutely necessary if you do not want to use the substrate provided in ADS, but intend to enter the substrate information directly. Once specified as described above, the Green's function required to perform the simulation can be computed. To do this, click *Momentum > Substrate > Precompute Substrate Function*. This computes the Green's function for the desired frequency range and, because the Green's function will be used repeatedly, it does not matter even if the calculation is done for a wider frequency range.

Ports and Reference Planes

Figure 2.3 is a conductor shape drawn on the layer named cond[4]. A microstrip line having a 25-mil width and 100-mil length is inserted on the substrate shown in Figure 2.1 and 2.2. The microstrip line is drawn first as a circuit in the Schematic window; the drawing is generated using the *Layout* > *Generate/Update Layout* commands on the menu bar of the Schematic window.



Figure 2.3. 25-mil-wide, 100-mil-long microstrip line

The input and output ports must be set up in order to perform Momentum simulations. To this end, the layer where the ports are connected must be specified as the inserting layer.

Afterselecting the **cond** layer as the inserting layer, the ports can be attached by clicking the \bigcirc icon. Then, the drawn shape appears, as shown in Figure 2.4[4].



Figure.2.4. The drawing after the ports are inserted

To set the parameters of the port, select Momentum > Ports > Editor on the menu bar. Click the port to display the Port Properties Editor window shown in Figure 2.5. Port modes include *Single, Internal, Differential, Coplanar, Common,* and *Ground Reference.* A *Single Mode* port is assigned by default, which can be widely used for a general microstrip-structure simulation. The port impedance can be set in the *Impedance* field and it can be set to a complex value using the *Real* and *Imaginary* fields. The port impedances become the reference impedances for the S-parameters. *Reference Offset* moves the reference line of the computed S-parameters. It is used to remove the effect of the length of the microstrip lines. When the *Port Properties Editor* settings are completed, new perpendicular lines are created that indicate the position of the reference plane.

Figure 2.6. Shows the window after completing the port setup[4]. The reference lines can be moved by entering the *Reference Offset* parameter in the *Port Properties Editor* window and can also be moved using the mouse by selecting the reference line and dragging it.

Port Type	100
Single Mode	~
Polarity Normal	O Reversed
Impedance Real	
50	Ohm 👻
Imaginary	
0	Ohm 👻
Reference Offset (+	+ = inward)
0	mil
Associate with por	t number
Port Info	
Single Mode STRIF - transmission line) port excitation

Figure 2.5. Port Properties Editor window

S [1	nom_	pri 1	exa	nple	e + (I	ayo	ut):17															
<u>File</u>	<u>E</u> dit	Sele	ct <u>V</u> i	ew	Inse	rt <u>O</u>	ptions	Tool	s S	<u>c</u> herr	atic	Morr	entur	n Ef	MDS	Wine	low	Desig	nGuid	e So	onnet	Help
	Þ	É	8	\bigcirc	 +) (• ()	Î	5	C	12.	•‡•	Q	Ð	+2Q	"Q	ť¢	1	۲	8	÷	6 <mark>0</mark>	dî »
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Selec	t: Ente	r the :	C iter	ns			conc	1	30,	0000,	30,00	00	14	15,0000), -10,	.0000		mil	A/RF	Sim	Schen	2

Figure 2.6. The window after completing the Port Properties Editor settings

Meshes

When the work to complete the port setup is finished, the electromagnetic problem setup of a structure is completed. Therefore, after creating a mesh in Momentum, the previously described matrix Equation is generated and solved. Even when a user does not specify the mesh, Momentum automatically generates the mesh after which the calculation is performed; however, the user can adjust the generation parameters of the mesh [4].

The *Mesh Frequency* is set in the *Global* tab of the Mesh Setup Controls window. The *Mesh Frequency* field determines the reference frequency for mesh generation and is normally set to the highest frequency of simulation. The *Mesh Density* field determines the cells per unit wavelength. In the case of a circuit that is 3-wavelengths long, setting the *Mesh Density* to 20 will create a total of 60 cells. A dense mesh is required in the case of complex structures, while

the default mesh value is adequate for simple circuits such as microstrips. The curve portions of the circuit are divided into triangular meshes. The *Arc Resolution* field determines the angle of triangular meshes and can be set up to a maximum of 45°. The smaller the angle, the more exact the analysis, but smaller angles should be avoided because they make processing time too long. The *Transmission Line Mesh* field defines the number of mesh per unit width of a microstrip line, and is disabled by default. Usually, the remaining entries use the given default values.

The conductor surface specified for Momentum calculations is divided into triangular or rectangular meshes. To set the mesh parameters, click *Momentum* > *Mesh* > *Setup* and the Mesh Setup Controls window shown in Figure 2.7 appears.

Freproces	sor settings	h
Mesh Frequency	20	GHz 😽
Mesh Density	20	cells/wavelength
Arc Resolution (max, 45 deg)	45	degrees
I ransmission Line Mesh Number of Cells Wide	0	

Figure 2.7. Mesh Setup Controls window

After the mesh setting is finished, the meshes can be shown in advance by clicking *Momentum* > *Mesh* > *Preview*; then, the highest frequency of the simulation frequency range, (20 GHz as shown in 2.7 is entered. Click OK and the layout window will display the mesh, as shown in 2.8.[4]



Figure 2.8. Microstrip lines are divided by mesh

Simulation and Data

Now the settings for Momentum simulation are completed. For the simulation, when you select *Momentum > Simulation > S-parameters*, the window shown in Figure 2.8 appears [4].

Frequency Plans Type F	'start Fstop	Npts/Step	Edit/Define Frequency Plan Sweep Type Adaptive
The second second second second second second second second second second second second second second second se	10,000 and 200	0000 GH2 C	Start 10 GHz Stop
<			Sample Points Limit
Cut	Paste	Update	Add to Frequency Plan List
Process mode: local	Solution Files Reuse files from to previous simulatio	he V	ta Display Open data display when simulation completes

Figure 2.9. Simulation Control window

Simulation frequencies can be selected using the *Edit/Define Frequency Plan* in the top-right corner of the window shown in Figure 2.9 [4]. Four types of frequency selections are provided: *Adaptive, Logarithmic, Linear* and *Single Point*. Adaptive simulation frequencies are computed by adaptive algorithm. Since the S-parameters of the given frequency range can be obtained by interpolating a small number of S-parameter samples, the algorithm determines the simulation frequencies so as to eliminate the uncertainty of the interpolated S-parameters. The Adaptive method is used because Momentum simulation requires a long computation time. The *Sample Points Limit* field specifies the maximum number of samples. The Logarithmic selection sets the simulation frequencies to increase logarithmically. The simulation frequencies are specified by

start and stop frequencies, and the numbers per decade. The Linear selection sets the simulation frequencies linearly to increase from the start to the stop frequencies. The Single Point selection is the simulation for one frequency.

The calculation results are stored as a dataset in the directory *data*. A user can identify the dataset by entering its name in the *Dataset* field; the default name is **layout name_mom**. There is a check box for whether or not previously simulated data will be reused; this, however, is usually not selected by default. In Figure 2.9, since *Open data display when simulation completes* is checked, the display window is opened automatically after simulation. The simulation frequency range is set to 10–20 GHz and the *Sweep Type* in Figure 2.9 is set to *Adaptive* and *Sample Points Limit* is set to 25.

When the simulation is finished, the display window will automatically open due to the selection of that option in Figure 9. In order to view the results, click the icon *Rectangular plot*

If the display window. The Plot Traces & Attributes window in Figure 10 opens and it will contain the computed S-parameters shown in Figure 2.10. The **S** here represents the S-parameters normalized by the port impedances set by the Port Properties Editor during Momentum set up. The port impedances were set to 50Ω . **S**_50 represents the S-parameters normalized by 50Ω . Therefore, **S**_50 and **S** are the same S-parameters in this case. However, if the port impedances set by the Port Properties Editor are different, the two are different S-parameters. Similarly **S**_**Z**0 represents the S-parameters normalized by impedance **Z**0. Momentum first solves the port impedances and propagation constants based on the cross-sectional shape of the ports, as explained previously. The results are stored in **Z**0 and **Gamma**, where **Z**0 represents the characteristic impedance and **Gamma** represents the propagation constant of the ports. Thus, **S**_**Z**0 represents the S-parameters normalized by impedance **Z**0 that is determined by Momentum.



Figure 2.10. Plot Traces & Attributes window

Figures 2.11 and 2.12 show **S** and **S_Z**0 [4]. The previously defined 100-mil-long by 25-mil-wide microstrip line has a characteristic impedance of approximately 29.3 Ω and an electrical length of 82° at 10 GHz when computed using **LineCalc**. The Momentum calculation results of **Z0** show a 29.7- Ω characteristic impedance that is close to that of the **LineCalc** computation. The impedance **Z**0 is used as a reference impedance for the normalized S-parameters **S_Z**0. Since the analyzed structure is a simple microstrip line, **S_Z**0 will show the small insertion loss with respect to frequency. This is shown in Figure 2.12, while the S-parameters shown in Figure 2.11 exhibit a significant insertion loss and return loss due to mismatch.



Figure 2.11. Momentum simulation results. The S-parameters represented by S in the dataset are the Sparameters with the reference impedances specified by the Port Properties Editor.



Figure 2.12. S_Z0 results. The S_Z0 represents the S-parameters with the reference impedances Z0, which represents the port impedances computed in the Momentum simulation.

However, in Figure 2.12 the return loss still shows an approximate value of -40 dB [4], which should be infinity. The exact reason for this is unknown, but may be due to dispersion in the microstrip line and cross-coupling of the port.

Summary

• The simulation in ADS is performed in the ADS Schematic/Layout window and the work in this window is saved in the network directory of the working project. The simulated data is saved in the data directory of the working project. The data can be viewed in the display window and the display window data is saved in the working project directory.

• Circuit simulations can be generally classified into DC, transient, AC, and harmonic balance. The S-parameter simulation is a kind of AC simulation.

• Layout is classified into two types, manual layout and auto layout. The layers, grid, and components are the basic design concepts in drawing a layout.

• Momentum is the tool for EM solving of a planar structure. The substrate structure, layer metallization, and assignment of ports are necessary for EM simulation of a planar structure.

• After the Momentum simulation, the S-parameters **S**, **S**_50, **S**_**Z**0 appear in the dataset and their physical meanings are explained. Also, port data **Z**0 and **Gamma** appear in the dataset and they represent the port impedances and propagation constants, respectively.

2.2 Envelope Simulation with ADS and software Limitation

Brief Explanation

Modulation-Oriented piecewise Harmonic-balance theory describes that the entire circuit/system is split into two sub networks, a linear explained concerning the frequency domain, and a nonlinear explained regarding the time-domain. The two sub-networks are connected using number (n_D) of standard (or device) ports. It is where the Kirchhoff current laws are applicable in the frequency domain. It is done to build the nonlinear solving system. In the given scenario, the linear portion contains radiating elements, too. A precise description of the linear sub-network is attained by resorting to full-wave numerical solvers; it is the typical case for high-frequency or compact microwave circuits or both.

From a circuit-level viewpoint, the presence of a radiating antenna requires the system output to be described regarding radiated field instead of standard circuit network operations. This calculation can be composed forthrightly as the antenna is a linear component. As an example, let us consider a steady-state regime under sinusoidal excitation, which is described by a set n_H of harmonics of the fundamental (angular) frequency. The n_A -dimensional vector of the excitation currents at the feeding points of the n_A monopoles can be represented in the form;

$$i_A(t) = Re[\sum_{k=1}^{n_H} I_{A,K} \exp(jk\omega_0 t)]$$
 2.1

Let us now establish a spherical coordinate system (r, θ , ϕ), with origin in the phase center of the antenna array. The far field radiated by the array at the fundamental frequency (k= 1) may be cast in the form

$$E(r,\theta,\phi;\omega_0) = \frac{\exp(-j\beta r)}{r} \sum_{i=1}^{n_A} [\widehat{\theta}A_{\theta}^{(i)}(\theta,\varphi;\omega_0) + \widehat{\phi}A_{\phi}^{(i)}(\theta,\varphi;\omega_0)] I_{A,1}^{(i)}$$
2.2

Where $\hat{\theta}, \hat{\emptyset}$ are unit vectors in the directions of θ, \emptyset , respectively, and the scalar components are $A_{\theta}^{(i)}, A_{\emptyset}^{(i)}$ of the normalized field. EM simulation generated these components with only the excited *i*th monopole by a sinusoidal unit-current source of angular frequency w_0 . If the non linear radiating system operates under modulated RF-drive the electrical regime is described as being dependent on 2 uncorrelated time variables which are known as t_M a slow envelope and t as a fast carrier time. According to the envelope analysis approach, the vector of eqn (2.1) representing the currents at the antenna feeding points is replaced by

$$\mathbf{i}_{A}^{(i)}(t, t_{M}) = \operatorname{Re}\left[\sum_{k=0}^{n_{H}} \boldsymbol{I}_{A,k}^{(i)}(t_{M}) \exp(jk2\pi f_{0}t)\right]$$
 2.3

That's the constant kth phasor $I_{A,K}$ of eqn-2.1 is replaced by the kthenvelope time dependent phasor $I_{A,K}(t_M)$. Sequentially the time-dependent modulation laws may explicitly formulated as

$$\boldsymbol{I}_{A,k}(t_M) = \sum_{h=-n_M}^{n_M} \boldsymbol{I}_{A,kh} \exp(jh\omega_M t_M) \qquad 2.4$$

Where w_M ($w_M \ll w_0$) is the angular modulation frequency, n_M is the significantly high number of harmonics (i.e. sidebands) and $I_{A,Kh}$ are the physical corresponding harmonics of the modulated (2-tone) regime.

The transfer of modulation to the radiated far-field from the driving currents happens as a natural consequence. The far-field envelope which depends on time may be computed for the speed of any modulation by the general algorithm of convolution envelope and the envelopes take on the form:

$$\begin{split} \tilde{\mathbf{E}}(r,\theta,\phi;t_M) &= \frac{\exp(-j\beta r)}{r} \cdot \sum_{i=1}^{n_A} \left[\hat{\boldsymbol{\theta}} A_{\theta}^{(i)}(\theta,\phi;\omega_0) + \hat{\boldsymbol{\phi}} A_{\phi}^{(i)}(\theta,\phi;\omega_0) \right] I_{A,1}^{(i)}(t_M) \\ &- j \frac{1}{r} \left[\sum_{i=1}^{n_A} \frac{\partial \left\{ \exp\left(-j\beta r\right) \left[\hat{\boldsymbol{\theta}} A_{\theta}^{(i)}\left(\theta,\phi;\omega\right) + \hat{\boldsymbol{\phi}} A_{\phi}^{(i)}\left(\theta,\phi;\omega\right) \right] \right\} \right|_{\omega=\omega_0} \cdot \frac{dI_{A,1}^{(i)}(t_M)}{dt_M} \right] \end{split}$$

The Fourier expansion of eqn-2.5 provides a result similar to eqn-2.4 i.e.

$$\tilde{\mathbf{E}}(r,\theta,\phi;t_M) = \sum_{h=-n_M}^{n_M} \tilde{\mathbf{E}}_h(r,\theta,\phi) \exp(jh\omega_M t_M)$$
 2.6

The eqn of the TMA radiation surface at the fundamental frequency becomes,

$$\begin{cases} r(\theta, \phi) = \frac{\|r\tilde{\mathbf{E}}_0(r, \theta, \phi)\|}{\|\mathbf{E}_{\mathbf{R}}\|} \\ 0 \le \theta \le \pi; 0 \le \phi < 2\pi \end{cases}$$
2.7

Where, an arbitrary constant E_R is a vector reference. For h≠0 eqns similar to eqn-2.7 (with the same E_R for appropriate evaluation) provide the sideband radiation patterns.

Accurate Co-Simulation Method of Coupled Non Linear/Electromagnetic System

According to the realistic approach to develop a time modulated linear array illustration first we have to design electromagnetically 2-element planar monopole array with corporate microstrip feed network, which operates in 2.45 GHz. The medium density substrate which has a value of 0.635 mm thick Taconic RF 60A ($\varepsilon_r = 6.15$, $tan\delta = 0.0028@10GHz$) for the compact solution. Along to the x-axis the array elements are aligned and $\lambda/2$ is the element spacing according to the standard broadside solution. Figure-2.1 shows the array layout with the partial ground plane for the microstrip corporate feed.



Figure 2.2.1. Linear broadside 2-monopole array with corporate feed network

We develop this array in ADS in its layout layer, where we have select the substrate & set all the parameters as aforementioned before.



2-Array element (ScreenShot taken from ADS)

Substrate1 [Thesis_lib] (Substrate):7	- 🗆 X
Substrate Name: substrate 1	Use right mouse context menus to add or delete substrate items. Select items on the substrate and view their properties below. Substrate Layer Material TaconicRF60 Thickness 0.635 Bounding area layer: <none> </none>
25 0 mil AIR AIR AIR AIR	

Toolbox where we have to define the substrate layer and conductors.

诸 Ant	enna [Thesis_lib:Antenna:layout] * (Layout):6					
File	substrate1 [Thesis_lib] * (Substrate):7			- 0 ×		
	File Technology View Options Tools Window Help					
Туре	🗋 📁 🖬 🏚 🤣 🥥 🖾 🚟 🎆					
emSe	Substrate Name: substrate1	Use right mous	context menus to add or delete s	substrate items.		
2	^	Select items on	the substrate and view their prop	erties below.		
Palette		Conductor	ayer		^	Properties
TLines		Layer	cond (1)	v		49 😯
Haclin			Only pins and pin shapes from	m layer		Property \
ڑتے `		Material	Copper	▼		
MSABN			Sheet			
MBstub		Operation	Intrude into substrate Expand the substrate			
đ	AIR		0			
Holin	Z5 TaconidF60	Position	Above interface Below interface			
•Ç≁ Moroso	U.d.s millimeter					
1	0 mil	Thickness	0.035	milimeter 🔻		
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·		Deserved as a second		1 21		\$
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HICAPo:		To move th	e conductor up or down on the sul	bstrate, just drag it up or		vertices or objects Press and hold Shift ,
TC	↓	domi.				Press M to move an o
Nlang	< >>					Press Ctrl+R to rotal Press Shift+X to mirr
Mang8						Press Shift+Y to mirr Press Ctrl+M to mea
	HL00					

In this case we have to set the same parameters for both conductors i.e. 2-array element.

After creating the antenna dimensions in layout, we have to define other parameters in EM simulator i.e. ports, frequency plan, model as they are important for EM simulation setup to generate the S-parameters for the Antenna.

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Output plan	v *ä 1	D1	TMI	50 . 0	pedance [0	1		[1111] in	ann ry⊧ aut-Out	
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	P4 Layout Pins									
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	Layout Pins Name Layer O+ P1 cond O+ P2 cond	Net N_4 N_3	Connected to 1(+) 2(+)	Purpose drawing drawing	X [mil] Y 799.213 3192.91 - 1	([mil] 110.236 110.236	Number 1 2	Layer Nur 1	m Pur -1 -1	pose Ni
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	Layout Pins Name Layer O+ P1 cond O+ P2 cond O+ P3 cond2 O+ P4 cond2 C+ P4 cond2 C+ P4 cond2 C+ P4 cond2	Net N_4 N_3 N_5 N_5 :ted layou	Connected to 1(+) 2(+) 1(-) 2(-) it pins o-center A	Purpose drawing drawing drawing drawing	X [mil] Y 799.213 - 3192.91 - 866.142 - 3267.72 -	([mil] 110.236 110.236 78.7402 78.7402	Number 1 2 3 4	Layer Nu 1 2 2	m Pur -1 -1 -1 -1	pose Nu
	Layout Pins Name Layer O+ P1 cond O+ P2 cond O+ P3 cond2 O+ P4 cond2 C Hide connec Auto-select	Net N_4 N_5 N_5 N_5	Connected to 1(+) 2(+) 1(-) 2(-) it pins o-center	Purpose drawing drawing drawing drawing	X [mil] Y 799.213 - 3192.91 - 866.142 - 3267.72 -	([mil] 110.236 110.236 78.7402 78.7402	Number 1 2 3 4	Layer Nur 1 2 2	m Pur -1 -1 -1 -1	pose Ni
	Layout Pins Name Layer P1 cond P2 cond P3 cond2 P4 cond2 C Hide connec Auto-select	Net N_4 N_3 N_5 N_5 ted layou	Connected to 1(+) 2(+) 1(-) 2(-) it pins o-center A	Purpose drawing drawing drawing drawing	X [mil] Y 799.213 - 3192.91 - 866.142 - 3267.72 -	/ [mil] 110.236 110.236 78.7402 78.7402	Number 1 2 3 4	Layer Nur 1 2 2	m Pur -1 -1 -1	pose Nu
	Layout Pins Name Layer P1 cond P2 cond P3 cond2 Hide connec Auto-select	Net N_4 N_3 N_5 N_5 ted layou	Connected to 1(+) 2(+) 1(-) 2(-) it pins o-center A	Purpose drawing drawing drawing uto-zoom	X [mil] Y 799.213 -1 866.142 -7 3267.72 -7	([mil] 110.236 110.236 78.7402 78.7402	Number 1 2 3 4	Layer Nu 1 2 2	m Pur -1 -1 -1 -1	pose Ni

We have to notice that the frequency of the (excitation) source in HB/Transient simulation tool must be included in the solution frequencies of the antenna analysis in momentum. Thus, if we want to see the results of F=2.45 GHz, we should have exactly the far-field and near-filed results of the antenna in this frequency. In our case in frequency definition in momentum should be adjust like this

EM Thesis_lib:Envelope:emSetup File Tools View Help) (EM S	etup for simula	tion)				-	×
🖥 🤊 ୯ 📽	ĚM	B 🏪 🗘	- 🗐	1	» 🏧			
✓ Mom uW Layout ⊕ Partitioning	Fr	equency Plan Add	Remove					
Substrate	1	Type Adaptive	Fstart 0 GHz	Fstop 10 GHz	Npts 35 (max)	Step	Enabled	
Frequency plan Output plan Output plan	2	Single	2.45 GHz	-	-	-		
Resources	3	Linear	0 GHz	10 GHz	50	0.204082 GHz		

Then create an EM model which will later use in non linear network in the schematic as a reference of 2 array element.



ADS

-50

-100

After simulated two patch antenna in the Momentum:





ADS

-5

-10-

dB(S22_fitted) IB(S22_discrete) dB(S21_fitted) JB(S21_discrete) -150 -15--200 -20--250 -25 -300--30--350 -35-1 2 3 5 6 7 8 ģ ό 1 3 7 8 9 10 4 10 2 5 6 Ó 4 freq, GHz freq, GHz

Then we create the antenna EM-model symbol as a lookalike (resembles to antenna) to use it in the schematic for envelope co-simulation.

The TMA is created by cutting the monopole feed line and by creating 2 internal ports to address the switching components. The current at those internal ports are used as the antenna excitation currents. This provides a major progress with respect to the non-linear/EM approach,

ģ 10 where the analysis is based on the assumption that the ports of antenna are transmission line ports. According to the schematic figure which we made in ADS



The non-linear radiating system has a non-linear sub-network with $n_D = 2$ device ports (diode based) and a linear network with n_e =3 (antenna feeding ports and the RF input port), where n_e is the external port numbers. We assume in our work we have only ONE RF signal as input and TWO biases. RF input is a sinusoidal signal of frequency 2.45GHz with 0dbm of available power. The two

additional external ports are used to bias the switches. Note that an asymmetric time-periodic sequence is used which means that the two biases must be two rectangular pulses with duty-cycle = 50%: one ON-OFF, the other OFF-ON. This is requested by the first step of the WPT procedure described in Chapter 2, in order to have localization capabilities.



Figure 2.2.2 First Bias On and Second Bias OFF

We use a traditional microwave Schottky diode as switching element and we refer to typical parameters values taken for its model description. In the examples we will use a "reference diode" with a sufficiently high cutoff frequency, whose model parameters are: saturation current I_s=5 nA, junction capacitance C_{j0} = 1fF, slope factor of conduction current α = $38.696V^{-1}$, built-in (diffusion) potential φ =0.7 V, series resistance .R_s = 6Ω .

Now we perform the nonlinear system analysis procedure, we perform an analysis by means of an envelope HB simulation with a 2.45 GHz carrier and the periodic time-based waveforms for the two switches, as described in Figure 2.2.2 in order to calculate the far-field radiation patterns in the xz (or $\phi = 0^{\circ}$) plane. The analysis under-modulated regime is performed by considering a switch modulation frequency $f_M \ll f_0$ equal to 1 MHz. Use Rectangular pulses sources with repetition period $T_M = 1$ us and amplitude $V_{bias} = 3$ V are applied at the two bias ports. Below voltage sources that we use our circuit in time domain as we perform our simulation according to Envelope HB principles.

a - 3
2 - 32
an 14
e - 82
2 C

Here is what we get (when running an envelope simulation to ON-OFF/OFF-ON state) in ADS at two sources for biasing



Where 5001 is totally arbitrary. The envelope simulation basically is a time varying harmonic balance, this is why v1 is a freq domain signal (or a set of freq domain signals).

ts(v1) will provide the Fourier transform of v1. **ts(v1,0,5e-6,5001)** is the numerical Fourier transform of v1, between 0 and 5 us, with 5001 time steps, but this is not necessarily related to the time step that we choose in the envelope setup. It is the number of points that we will get to describe the transformed signal.

In other words, we don't need to simulate 5001 time points. Of course if our time step is too coarse we will not catch the proper t_rise and t_fall.

Note that if we plot ts(v1), then t_start, t_stop and number of points will be at the default value that can lead to a not accurate Fourier transform.

After performing the envelope EM-cosimulation in ADS we get the results in electrical quantities, as in the figures below, where we can see the antenna input currents envelopes and the corresponding zoom on the right (the short period of the carrier inside the long modulation one is clearly visible).



When we try to see the far-field at fundamental frequency @2.45 GHz, it shows that Envelope engine is not supported to see the far-field. We can run EM Circuit Excitation either with transient or with harmonic balance. In this case, we need to modify the sources accordingly (they will be all time domain or all freq domain sources, depending on the type of analysis). Primarily our goal was to make the envelope co-simulation with the antenna element and trying to obtain the far-field at the fundamental

(2.45 GHz) and at the harmonics (2.45 GHz +- modulation frequency). Due to this fact we stop our envelope co simulation and move to standard harmonic balance simulation which is much heavier but still supported by ADS software.

2.3 ADS Harmonic Balance Inter-modulation Analysis

Previously, we encountered a problem in Envelope Co-simulation that we were unable to perform EM-circuit excitation to see far-field at fundamental frequency. Now in this section we perform and analyze the standard HB inter-modulation simulation with the same 2-array element monopole to see the normalized far-field at different resonant frequencies.

Non-Linear and Full Wave Co-Simulation

This method includes EM/nonlinear analysis of the entire radiating structure by combining the standard (not envelope-based) harmonic balance approach for the precise illustration of the non-linearities, the broadband full wave of the array and its feeding network. An array in this case with nA ports (identical in terms of switches numbers), description of the EM-based structure will consists of nA +1-port network (input RF port included).

Detailed theory of Wireless Power Transfer Approach in Two Step

The WPT two-step procedure exploiting TMAs considers several sensors are equipped with rectennas and are placed randomly inside room as per idea. A linear TMA is fully deployed with dynamic reconfigurability in a novel WPT 2-step procedure, as represented in Fig 2.3.1 [1]: in the first step only two elements of the TMA are periodically driven to localize N_{tags} . While in the second step, the entire n_A -element array is used to precisely energize the previously detected tags. We take advantage, in both phases from the capability of TMA to perform a multiple radiation at the fundamental and the first sideband harmonics $f_0 + f_M$. In practice in my work, I have tried to reproduce the first step of this procedure with ADS.



Figure 2.3.1 WPT procedure in 2-steps exploiting a linear TMA. Step-1: Localization of tags, Step-2: power transmission to the previously detected tags.

In the first case we modify our circuit with one RF power generator of -0dbm and also change the voltage sources to Vn_tones in frequency domain as we perform a simulation in the frequency domain. Of course, we need to select a sufficiently high number of harmonics (h) to accurately describe through Foureir transformation the bias pulses in the frequency domain. h=50 was selected as a good tradeoff between accuracy and complexity of the simulation

Then we have included two "Vn_tones" sources where we have to enter the 51 values of frequencies (including DC) and the 51 complex amplitudes (V[1], V[2],...) through the "polar" command.



The sideband input HB generators at h*F2 (with h=0,1,2,...,50) have the values obtained from the Fourier transformation of the two bias waveforms. Corresponding to the following indexes:

indexes 0 0 --> 0 Hz indexes 0 1 --> 100 kHz indexes 0 2 --> 200 kHz ... indexes 0 100 --> 10 MHz

For the First bias we have to input the values given below;

Frequency (Hz)	Amplitude of the corresponding generator	Phase of the corresponding generator
1. 0.000000E+00	0.150000E+01	0.000
2. 0.100000E+06	0.190986E+01	-90.180
3. 0.200000E+06	0.00000E+00	0.000
4. 0.300000E+06	0.636629E+00	-90.540
5. 0.400000E+06	0.00000E+00	0.000
6. 0.500000E+06	0.381988E+00	-90.900
7. 0.600000E+06	0.00000E+00	0.000
8. 0.70000E+06	0.272859E+00	-91.260
9. 0.800000E+06	0.00000E+00	0.000
10. 0.900000E+06	0.212235E+00	-91.620
11. 0.100000E+07	0.00000E+00	0.000
12. 0.110000E+07	0.173658E+00	-91.980
13. 0.120000E+07	0.00000E+00	0.000
14. 0.130000E+07	0.146953E+00	-92.340
15. 0.140000E+07	0.00000E+00	0.000
16. 0.150000E+07	0.127371E+00	-92.700
17. 0.160000E+07	0.00000E+00	0.000
18. 0.170000E+07	0.112398E+00	-93.060
19. 0.180000E+07	0.000000E+00	0.000
20. 0.190000E+07	0.100579E+00	-93.420
21. 0.200000E+07	0.00000E+00	0.000
22. 0.210000E+07	0.910117E-01	-93.780
23. 0.220000E+07	0.00000E+00	0.000
24. 0.230000E+07	0.831097E-01	-94.140
25. 0.240000E+07	0.00000E+00	0.000
26. 0.250000E+07	0.764730E-01	-94.500
27. 0.260000E+07	0.00000E+00	0.000
28. 0.270000E+07	0.708204E-01	-94.860
29. 0.280000E+07	0.00000E+00	0.000

30. 0.290000E+07	0.659484E-01	-95.220
31. 0.30000E+07	0.000000E+00	0.000
32. 0.310000E+07	0.617059E-01	-95.580
33. 0.320000E+07	0.00000E+00	0.000
34. 0.330000E+07	0.579783E-01	-95.940
35. 0.340000E+07	0.000000E+00	0.000
36. 0.350000E+07	0.546775E-01	-96.300
37. 0.360000E+07	0.000000E+00	0.000
38. 0.370000E+07	0.517342E-01	-96.660
39. 0.380000E+07	0.00000E+00	0.000
40. 0.390000E+07	0.490935E-01	-97.020
41. 0.400000E+07	0.666458E-16	151.200
42. 0.410000E+07	0.467110E-01	-97.380
43. 0.420000E+07	0.000000E+00	0.000
44. 0.430000E+07	0.445507E-01	-97.740
45. 0.440000E+07	0.000000E+00	0.000
46. 0.450000E+07	0.425830E-01	-98.100
47. 0.460000E+07	0.000000E+00	0.000
48. 0.470000E+07	0.407833E-01	-98.460
49. 0.480000E+07	0.000000E+00	0.000
50. 0.490000E+07	0.391311E-01	-98.820

And For the Second bias we have to input below Values

Frequency (Hz)	Amplitude of the corresponding generator	Phase of the corresponding generator
1. 0.000000E+00	0.150000E+01	0.000
2. 0.100000E+06	0.190986E+01	90.180
3. 0.200000E+06	0.000000E+00	0.000
4. 0.300000E+06	0.636629E+00	90.540
5. 0.400000E+06	0.000000E+00	0.000
6. 0.500000E+06	0.381988E+00	90.900
7. 0.600000E+06	0.00000E+00	0.000
8. 0.700000E+06	0.272859E+00	91.260
9. 0.800000E+06	0.00000E+00	0.000
10. 0.900000E+06	0.212235E+00	91.620
11. 0.100000E+07	0.00000E+00	0.000
12. 0.110000E+07	0.173658E+00	91.980
13. 0.120000E+07	0.00000E+00	0.000
14. 0.130000E+07	0.146953E+00	92.340

15. 0.140000E+07	0.00000E+00	0.000
16. 0.150000E+07	0.127371E+00	92.700
17. 0.160000E+07	0.00000E+00	0.000
18. 0.170000E+07	0.112398E+00	93.060
19. 0.180000E+07	0.00000E+00	0.000
20. 0.190000E+07	0.100579E+00	93.420
21. 0.200000E+07	0.00000E+00	0.000
22. 0.210000E+07	0.910117E-01	93.780
23. 0.220000E+07	0.00000E+00	0.000
24. 0.230000E+07	0.831097E-01	94.140
25. 0.240000E+07	0.000000E+00	0.000
26. 0.250000E+07	0.764730E-01	94.500
27. 0.260000E+07	0.00000E+00	0.000
28. 0.270000E+07	0.708204E-01	94.860
29. 0.280000E+07	0.00000E+00	0.000
30. 0.290000E+07	0.659484E-01	95.220
31. 0.300000E+07	0.000000E+00	0.000
32. 0.310000E+07	0.617059E-01	95.580
33. 0.320000E+07	0.000000E+00	0.000
34. 0.330000E+07	0.579783E-01	95.940
35. 0.340000E+07	0.000000E+00	0.000
36. 0.350000E+07	0.546775E-01	96.300
37. 0.360000E+07	0.000000E+00	0.000
38. 0.370000E+07	0.517342E-01	96.660
39. 0.380000E+07	0.000000E+00	0.000
40. 0.390000E+07	0.490935E-01	97.020
41. 0.400000E+07	0.666458E-16	151.200
42. 0.410000E+07	0.467110E-01	97.380
43. 0.420000E+07	0.000000E+00	0.000
44. 0.430000E+07	0.445507E-01	97.740
45. 0.440000E+07	0.000000E+00	0.000
46. 0.450000E+07	0.425830E-01	98.100
47. 0.460000E+07	0.00000E+00	0.000
48. 0.470000E+07	0.407833E-01	98.460
49. 0.480000E+07	0.00000E+00	0.000
50. 0.490000E+07	0.391311E-01	98.820

Then it is sufficient to have just two harmonics for 2.45 GHz (Order = 2) (otherwise the simulation is too heavy), whereas we need an Order = 50 for the modulation frequency. As

regards the Max-order, at least 51 should be placed, in order to have all the lines around the fundamental (2.45 GHz +- $n*f_mod$).



We define both fundamental frequencies in the HB controller with the number of harmonics and we need to have consistent settings between sources and HB controller, that is the same number of harmonics used to build the pulse have to be used in the HB controller. We can start our simulation using 50 harmonics. Therefore we have to create a simulation with F1 = 2.45 GHz, and F2=100 kHz. The fundamental input HB generator at F1 will be the usual one (freq. corresponding to indexes 1 0)

Later we can see the far-field results will be extracted at the frequencies:

1 0 (=2.45 GHz) for the SUM pattern

1 1 (=2.4501 GHz) for the DIFFERENCE pattern

1 -1 (=2.4499 GHz) for the DIFFERENCE pattern (identical to the previous one)

We have to notice that the frequency of the (excitation) source in HB simulation tool must be included in the solution frequencies of the antenna analysis in momentum. Thus, if we want to see the results of F=2.45 GHz, 2.4501 GHz and 2.4499GHz, we should have exactly the far-field and near-filed results of the antenna in this frequency. In our case in frequency definition in momentum should be adjust like this in below image:

EM Thesis_lib:Antenna:emSetup	(EM Setup for simulation)	-	o x
File Tools View Help			
199	👫 🔁 🏣 🗁 🗐 🗊 🐁 🌉		
Mom uW	Frequency Plan		
Layout	Add Remove		
Substrate	Type Fstart Fstop Npts Step	Enabled	
Frequency plan	1 Adaptive 0 GHz 10 GHz 35 (max) -		
WW Output plan	2 Single 2.45 GHz		
Deptions	3 Single 2.4499 GHz		
Model	4 Single 2.4501 GHz		

Below image is the representation of our circuit in ADS.



Localization Step-1

By driving these switches properly, an interesting direction finding functionality of two-element TMA is deployable exploiting the TMA sideband radiation SBR. We choose a complementary control sequence of the kind reported in Figure. 2.3.2 With solid lines (i.e., 50% of duty cycle for both switches) [1] to obtain from the two-element array symmetric radiation surfaces both of the sum type Σ at f_0 (two elements in-phase), and of the difference type Δ , but at $f_0 \pm f_M$ (two elements out-of-phase). Figure 2.3.2. also shows the tuning parameter allowing a variable overlapping percentage of the control sequences [1]: in this way beam steering of the Δ pattern is achieved in the scanning plane (-90° $\leq \theta \leq$ 90) increasing d results in a shift increase of the Δ null in the right half-plane at $(-0^{\circ} \leq \theta \leq 90)$ a symmetric result in the left half-plane (-90° $\leq \theta \leq 0$) is observed at $f_0 \pm f_M$.



Figure.2.3.2 Switches driving sequences of a two-element array for localization purposes d is the pulse shape design parameter for pattern steering.

The steering Δ pattern is made possible by the complex nature of the corresponding Fourier coefficient $u_{\pm li}$ in eqn (2). Conversely, the real coefficient u_{0i} is responsible for the fixed nature of the Σ pattern, while changing d.

That sensor identifications (IDs) have been already acquired by standard RF identification (RFID) reading operations of passive tags. The (flat) Σ pattern of a standard (unmodulated) twoelement array could be used for this purpose. When tag IDs are acquired, the true scanning phase takes place, by exploiting the time modulation according to the patterns of Figure. 2.3.2. The sharp nulls of the steered Δ patterns allow high resolution in the tags detection: the backscattered received signal strength indicators (RSSIs) due to the Δ and Σ patterns can be suitably combined to build the maximum power ratio (MPR),

$$MPR(\theta_j) = \sum_{RSSI}^{dB} (\theta_j) - \Delta_{RSSI}^{dB} (\theta_j), \qquad j = 1, 2, \dots, N_{tag}.$$
(5)

The combination of the radar monopulse operating principle with the scanning capability has proven its effectiveness in indoor localization, with resolution up to a few cm at 2.45 GHz. At

the end of the scanning activity a vector with the N_{tag} values of corresponding to the peaks of the received MPRs (θ_{peak}) is recorded.

Power Transfer Step-2

Once the tags positions have been detected, the entire array is driven by a proper control sequence involving all the switches and providing the desired radiation properties. From this side, there is plenty of optimization strategies for the engineering of the radiation patterns shape of ideal TMAs. In particular, it is possible to add, as an additional design parameter, the maximum radiation direction at the sideband harmonics $f_0 \pm h f_M$ ($h \neq 0$). In this way it is possible to point the sideband harmonic radiation in the desired direction, and this can be done simultaneously at several near-carrier frequencies ($h \ge 1$).

Now, perform the EM-circuit excitation for HB simulation to extract the far field radiation pattern at multiple resonant frequencies.



Left image refers to the extracted far-field at f=2.4490 GHz



Above image refers to the extracted far-field at f=2.4500 GHz

Right image refers to the extracted far-field at f=2.4501 GHz



While the corresponding far-field radiation patterns (in the xz plane) are given below, and they correspond to the theoretical ones:



1. At f=2.4499Ghz (φ, θ)

While the total field and gain are:



2. At f= 2.4500Ghz (ϕ , θ)



While the total field and gain are:



3. At f= 2.4501 Ghz (φ, θ)



While the total field and gain are:



Frequency (Hz)	Amplitude of the corresponding generator	Phase of the corresponding generator
1. 0.000000E+00	0.174000E+01	0.000
2. 0.100000E+06	0.184986E+01	-104.580
3. 0.200000E+06	0.460044E+00	-29.160
4. 0.300000E+06	0.464083E+00	-133.740
5. 0.400000E+06	0.403147E+00	-58.320
6. 0.500000E+06	0.118041E+00	-162.900
7. 0.600000E+06	0.317701E+00	-87.480
8. 0.700000E+06	0.511287E-01	-12.060
9. 0.800000E+06	0.216034E+00	-116.640
10. 0.900000E+06	0.135284E+00	-41.220
11. 0.100000E+07	0.112277E+00	-145.800
12. 0.110000E+07	0.161463E+00	-70.380
13. 0.120000E+07	0.199521E-01	-174.960
14. 0.130000E+07	0.145794E+00	-99.540
15. 0.140000E+07	0.502352E-01	-24.120
16. 0.150000E+07	0.103045E+00	-128.700
17. 0.160000E+07	0.920120E-01	-53.280
18. 0.170000E+07	0.478568E-01	-157.860
19. 0.180000E+07	0.104279E+00	-82.440
20. 0.190000E+07	0.631538E-02	-7.020
21. 0.200000E+07	0.908790E-01	-111.600
22. 0.210000E+07	0.487665E-01	-36.180
23. 0.220000E+07	0.594741E-01	-140.760
24. 0.230000E+07	0.728296E-01	-65.340
25. 0.240000E+07	0.198089E-01	-169.920
26. 0.250000E+07	0.764730E-01	-94.500
27. 0.260000E+07	0.182881E-01	-19.080
28. 0.270000E+07	0.620604E-01	-123.660
29. 0.280000E+07	0.467527E-01	-48.240
30. 0.290000E+07	0.353369E-01	-152.820
31. 0.300000E+07	0.606359E-01	-77.400
32. 0.310000E+07	0.387454E-02	178.020
33. 0.320000E+07	0.587248E-01	-106.560
34. 0.330000E+07	0.246860E-01	-31.140
35. 0.340000E+07	0.433639E-01	-135.720
36. 0.350000E+07	0.442350E-01	-60.300

In order to check the tuning capability of the Difference pattern by acting on the duty-cycle (d) of the biases, now we consider for d = 8%, For the First bias we have to input below values

37. 0.360000E+07	0.195713E-01	-164.880
38. 0.370000E+07	0.513263E-01	-89.460
39. 0.380000E+07	0.631417E-02	-14.040
40. 0.390000E+07	0.456460E-01	-118.620
41. 0.400000E+07	0.281387E-01	-43.200
42. 0.410000E+07	0.297747E-01	-147.780
43. 0.420000E+07	0.412647E-01	-72.360
44. 0.430000E+07	0.834797E-02	-176.940
45. 0.440000E+07	0.434585E-01	-101.520
46. 0.450000E+07	0.131589E-01	-26.100
47. 0.460000E+07	0.351777E-01	-130.680
48. 0.470000E+07	0.297298E-01	-55.260
49. 0.480000E+07	0.192412E-01	-159.840
50. 0.490000E+07	0.379017E-01	-84.420

And For the Second bias we have to input below values:

Frequency (Hz)	Amplitude of the corresponding generator	Phase of the corresponding generator
1. 0.000000E+00	0.174000E+01	0.000
2. 0.100000E+06	0.184986E+01	104.580
3. 0.200000E+06	0.460044E+00	29.160
4. 0.300000E+06	0.464083E+00	133.740
5. 0.400000E+06	0.403147E+00	58.320
6. 0.500000E+06	0.118041E+00	162.900
7. 0.600000E+06	0.317701E+00	87.480
8. 0.700000E+06	0.511287E-01	12.060
9. 0.800000E+06	0.216034E+00	116.640
10. 0.900000E+06	0.135284E+00	41.220
11. 0.100000E+07	0.112277E+00	145.800
12. 0.110000E+07	0.161463E+00	70.380
13. 0.120000E+07	0.199521E-01	174.960
14. 0.130000E+07	0.145794E+00	99.540
15. 0.140000E+07	0.502352E-01	24.120
16. 0.150000E+07	0.103045E+00	128.700
17. 0.160000E+07	0.920120E-01	53.280
18. 0.170000E+07	0.478568E-01	157.860
19. 0.180000E+07	0.104279E+00	82.440
20. 0.190000E+07	0.631538E-02	7.020
21. 0.200000E+07	0.908790E-01	111.600
22. 0.210000E+07	0.487665E-01	36.180

23. 0.220000E+07	0.594741E-01	140.760
24. 0.230000E+07	0.728296E-01	65.340
25. 0.240000E+07	0.198089E-01	169.920
26. 0.250000E+07	0.764730E-01	94.500
27. 0.260000E+07	0.182881E-01	19.080
28. 0.270000E+07	0.620604E-01	123.660
29. 0.280000E+07	0.467527E-01	48.240
30. 0.290000E+07	0.353369E-01	152.820
31. 0.300000E+07	0.606359E-01	77.400
32. 0.310000E+07	0.387454E-02	-178.020
33. 0.320000E+07	0.587248E-01	106.560
34. 0.330000E+07	0.246860E-01	31.140
35. 0.340000E+07	0.433639E-01	135.720
36. 0.350000E+07	0.442350E-01	60.300
37. 0.360000E+07	0.195713E-01	164.880
38. 0.370000E+07	0.513263E-01	89.460
39. 0.380000E+07	0.631417E-02	14.040
40. 0.390000E+07	0.456460E-01	118.620
41. 0.400000E+07	0.281387E-01	43.200
42. 0.410000E+07	0.297747E-01	147.780
43. 0.420000E+07	0.412647E-01	72.360
44. 0.430000E+07	0.834797E-02	176.940
45. 0.440000E+07	0.434585E-01	101.520
46. 0.450000E+07	0.131589E-01	26.100
47. 0.460000E+07	0.351777E-01	130.680
48. 0.470000E+07	0.297298E-01	55.260
49. 0.480000E+07	0.192412E-01	159.840
50. 0.490000E+07	0.379017E-01	84.420

Now, for d = 16%, For the First bias we have to input below values

Frequency (Hz)	Amplitude of the corresponding generator	Phase of the corresponding generator
1. 0.000000E+00	0.198000E+01	0.000
2. 0.100000E+06	0.167363E+01	-118.980
3. 0.200000E+06	0.806279E+00	-57.960
4. 0.300000E+06	0.399743E-01	-176.940
5. 0.400000E+06	0.432034E+00	-115.920
6. 0.500000E+06	0.309034E+00	-54.900
7. 0.600000E+06	0.398972E-01	-173.880

8. 0.700000E+06	0.253698E+00	-112.860
9. 0.800000E+06	0.183966E+00	-51.840
10. 0.900000E+06	0.397688E-01	-170.820
11. 0.100000E+07	0.181668E+00	-109.800
12. 0.110000E+07	0.126591E+00	-48.780
13. 0.120000E+07	0.395896E-01	-167.760
14. 0.130000E+07	0.142336E+00	-106.740
15. 0.140000E+07	0.934150E-01	-45.720
16. 0.150000E+07	0.393598E-01	-164.700
17. 0.160000E+07	0.117301E+00	-103.680
18. 0.170000E+07	0.716452E-01	-42.660
19. 0.180000E+07	0.390801E-01	-161.640
20. 0.190000E+07	0.997855E-01	-100.620
21. 0.200000E+07	0.561663E-01	-39.600
22. 0.210000E+07	0.387509E-01	-158.580
23. 0.220000E+07	0.867095E-01	-97.560
24. 0.230000E+07	0.445324E-01	-36.540
25. 0.240000E+07	0.383731E-01	-155.520
26. 0.250000E+07	0.764730E-01	-94.500
27. 0.260000E+07	0.354271E-01	-33.480
28. 0.270000E+07	0.379475E-01	-152.460
29. 0.280000E+07	0.681625E-01	-91.440
30. 0.290000E+07	0.280795E-01	-30.420
31. 0.300000E+07	0.374750E-01	-149.400
32. 0.310000E+07	0.612193E-01	-88.380
33. 0.320000E+07	0.220079E-01	-27.360
34. 0.330000E+07	0.369568E-01	-146.340
35. 0.340000E+07	0.552824E-01	-85.320
36. 0.350000E+07	0.168963E-01	-24.300
37. 0.360000E+07	0.363939E-01	-143.280
38. 0.370000E+07	0.501089E-01	-82.260
39. 0.380000E+07	0.125288E-01	-21.240
40. 0.390000E+07	0.357876E-01	-140.220
41. 0.400000E+07	0.455293E-01	-79.200
42. 0.410000E+07	0.875277E-02	-18.180
43. 0.420000E+07	0.351393E-01	-137.160
44. 0.430000E+07	0.414222E-01	-76.140
45. 0.440000E+07	0.545756E-02	-15.120
46. 0.450000E+07	0.344504E-01	-134.100
47. 0.460000E+07	0.376983E-01	-73.080
48. 0.470000E+07	0.256081E-02	-12.060

49. 0.480000E+07	0.337224E-01	-131.040
50. 0.490000E+07	0.342908E-01	-70.020

And For the second bias we have to input below values

Frequency (Hz)	Amplitude of the corresponding generator	Phase of the corresponding generator
1. 0.000000E+00	0.198000E+01	0.000
2. 0.100000E+06	0.167363E+01	118.980
3. 0.200000E+06	0.806279E+00	57.960
4. 0.300000E+06	0.399743E-01	176.940
5. 0.400000E+06	0.432034E+00	115.920
6. 0.500000E+06	0.309034E+00	54.900
7. 0.600000E+06	0.398972E-01	173.880
8. 0.700000E+06	0.253698E+00	112.860
9. 0.800000E+06	0.183966E+00	51.840
10. 0.900000E+06	0.397688E-01	170.820
11. 0.100000E+07	0.181668E+00	109.800
12. 0.110000E+07	0.126591E+00	48.780
13. 0.120000E+07	0.395896E-01	167.760
14. 0.130000E+07	0.142336E+00	106.740
15. 0.140000E+07	0.934150E-01	45.720
16. 0.150000E+07	0.393598E-01	164.700
17. 0.160000E+07	0.117301E+00	103.680
18. 0.170000E+07	0.716452E-01	42.660
19. 0.180000E+07	0.390801E-01	161.640
20. 0.190000E+07	0.997855E-01	100.620
21. 0.200000E+07	0.561663E-01	39.600
22. 0.210000E+07	0.387509E-01	158.580
23. 0.220000E+07	0.867095E-01	97.560
24. 0.230000E+07	0.445324E-01	36.540
25. 0.240000E+07	0.383731E-01	155.520
26. 0.250000E+07	0.764730E-01	94.500
27. 0.260000E+07	0.354271E-01	33.480
28. 0.270000E+07	0.379475E-01	152.460
29. 0.280000E+07	0.681625E-01	91.440
30. 0.290000E+07	0.280795E-01	30.420
31. 0.300000E+07	0.374750E-01	149.400
32. 0.310000E+07	0.612193E-01	88.380
33. 0.320000E+07	0.220079E-01	27.360
34. 0.330000E+07	0.369568E-01	146.340

35. 0.340000E+07	0.552824E-01	85.320
36. 0.350000E+07	0.168963E-01	24.300
37. 0.360000E+07	0.363939E-01	143.280
38. 0.370000E+07	0.501089E-01	82.260
39. 0.380000E+07	0.125288E-01	21.240
40. 0.390000E+07	0.357876E-01	140.220
41. 0.400000E+07	0.455293E-01	79.200
42. 0.410000E+07	0.875277E-02	18.180
43. 0.420000E+07	0.351393E-01	137.160
44. 0.430000E+07	0.414222E-01	76.140
45. 0.440000E+07	0.545756E-02	15.120
46. 0.450000E+07	0.344504E-01	134.100
47. 0.460000E+07	0.376983E-01	73.080
48. 0.470000E+07	0.256081E-02	12.060
49. 0.480000E+07	0.337224E-01	131.040
50. 0.490000E+07	0.342908E-01	70.020

For $m{d}=m{8}\%$, Then the EM-circuit simulation provides the following results:



Left image refers to the Far-field extracted @ f= 2.4499Ghz

Right image refers to the Far-field extracted @2.4501Ghz



Below image refers to the Far-field extracted @ 2.4500Ghz



While the corresponding far-fields radiation patterns in the xz plane are given below (named **Figure 2.3.3 B**):



1. At f=2.4499Ghz (ϕ , θ) Δ pattern @ $f_0 \pm f_M$

2. At f=2.4500 Ghz (ϕ , θ) Σ pattern @ f_0



3. At f=2.4501 Ghz (ϕ , θ) Δ pattern @ $f_0 \pm f_M$



The steering of the Difference is not so clearly visible (the 2.4501 pattern is a bit shifted, the other one no)



And there total field and gain respectively from 2.4499, 2.4500 and 2.4501 GHz:





For d = 16%, Then the EM-circuit simulation provides the following results:



Left image refers to the far-field extracted at 2.4499GHz

Right image refers to the far-field extracted at 2.4500GHz



Below image refers to the far-field extracted at 2.4501GHz



While the corresponding far-fields radiation patterns in the xz plane are given below (named **Figure 2.3.3 C**):



1. At f=2.4499Ghz (ϕ , θ) Δ pattern @ $f_0 \pm f_M$

2. At f=2.4500 Ghz (ϕ , θ) Σ pattern @ f_0



3. At f=2.4501 Ghz (ϕ , θ) Δ pattern @ $f_0 \pm f_M$



The steering of the difference is visible.



Theta (-180.000 to 180.000)

And there total field and gain respectively from 2.4499, 2.4500 and 2.4501 GHz:



Theta (-180.000 to 180.000)



Figure 2.3.3(A,B,C) shows the radiation patterns in the scanning plane of an array of two planar monopoles with $L=\lambda/2$, thus they correspond to the AF patterns obtained from eqn(2) with

 $U_i(t)(i = 1,2)$ given by the waveforms of Figure 2.3.2. With an increase d of up to 16%, a scanning region of about \pm 15 is achieved.

References

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